



**ALPHA & OMEGA**  
SEMICONDUCTOR

**AO4484**  
**40V N-Channel MOSFET**

### General Description

The AO4484 uses advanced trench technology to provide excellent  $R_{DS(ON)}$  with low gate charge. This is an all purpose device that is suitable for use in a wide range of power conversion applications.

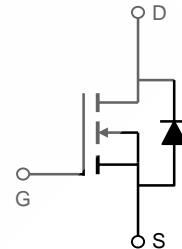
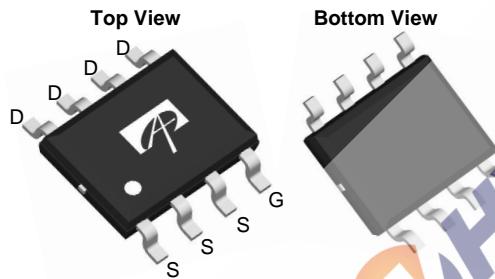
### Product Summary

$V_{DS}$  (V) = 40V  
 $I_D$  = 10A ( $V_{GS}$  = 10V)  
 $R_{DS(ON)} < 10m\Omega$  ( $V_{GS}$  = 10V)  
 $R_{DS(ON)} < 12m\Omega$  ( $V_{GS}$  = 4.5V)

100% UIS Tested  
100%  $R_g$  Tested



SOIC-8



### Absolute Maximum Ratings $T_J=25^\circ C$ unless otherwise noted

Parameter	Symbol	10 Sec	Steady State	Units
Drain-Source Voltage	$V_{DS}$	40		V
Gate-Source Voltage	$V_{GS}$	+20		V
Continuous Drain Current <sup>A</sup>	$I_D$	13.5	10	A
$T_A=70^\circ C$		10.8	8	
Pulsed Drain Current <sup>B</sup>	$I_{DM}$	120		
Avalanche Current <sup>G</sup>	$I_{AR}$	23		
Repetitive avalanche energy $L=0.3mH$ <sup>G</sup>	$E_{AR}$	79		mJ
Power Dissipation <sup>A</sup>	$P_D$	3.1	1.7	W
$T_A=70^\circ C$		2.0	1.1	
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150		°C

### Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient <sup>A</sup>	$R_{\theta JA}$	31	40	°C/W
Steady State		59	75	°C/W
Maximum Junction-to-Lead <sup>C</sup>	$R_{\theta JL}$	16	24	°C/W

Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>STATIC PARAMETERS</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$	40			V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{DS} = 40\text{V}, V_{GS} = 0\text{V}$		1		$\mu\text{A}$
		$T_J = 55^\circ\text{C}$		5		
$I_{\text{GSS}}$	Gate-Body leakage current	$V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$			$\pm 100$	nA
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1.7	2.2	3	V
$I_{D(\text{ON})}$	On state drain current	$V_{GS} = 10\text{V}, V_{DS} = 5\text{V}$	120			A
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS} = 10\text{V}, I_D = 10\text{A}$		8.2	10	$\text{m}\Omega$
		$T_J = 125^\circ\text{C}$		12.5	16	
$g_{FS}$	Forward Transconductance	$V_{DS} = 5\text{V}, I_D = 10\text{A}$		75		S
$V_{SD}$	Diode Forward Voltage	$I_S = 1\text{A}, V_{GS} = 0\text{V}$		0.72	1	V
$I_S$	Maximum Body-Diode Continuous Current				2.5	A
<b>DYNAMIC PARAMETERS</b>						
$C_{iss}$	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=20\text{V}, f=1\text{MHz}$		1500	1950	pF
$C_{oss}$	Output Capacitance			215		pF
$C_{rss}$	Reverse Transfer Capacitance			135		pF
$R_g$	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$	2	3.5	5	$\Omega$
<b>SWITCHING PARAMETERS</b>						
$Q_g(10\text{V})$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=20\text{V}, I_D=10\text{A}$		27.2	37	nC
$Q_g(4.5\text{V})$	Total Gate Charge			13.6	18	nC
$Q_{gs}$	Gate Source Charge			4.5		nC
$Q_{gd}$	Gate Drain Charge			6.4		nC
$t_{D(\text{on})}$	Turn-On DelayTime	$V_{GS}=10\text{V}, V_{DS}=20\text{V}, R_L=2\Omega, R_{\text{GEN}}=3\Omega$		6.4		ns
$t_r$	Turn-On Rise Time			17.2		ns
$t_{D(\text{off})}$	Turn-Off DelayTime			29.6		ns
$t_f$	Turn-Off Fall Time			16.8		ns
$t_{rr}$	Body Diode Reverse Recovery Time	$I_F=10\text{A}, dI/dt=100\text{A}/\mu\text{s}$		30	40	ns
$Q_{rr}$	Body Diode Reverse Recovery Charge	$I_F=10\text{A}, dI/dt=100\text{A}/\mu\text{s}$		19		nC

A: The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ . The value in any given application depends on the user's specific board design.

B: Repetitive rating, pulse width limited by junction temperature.

C. The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to lead  $R_{\theta JL}$  and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using  $t \leq 300\mu\text{s}$  pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The SOA curve provides a single pulse rating.

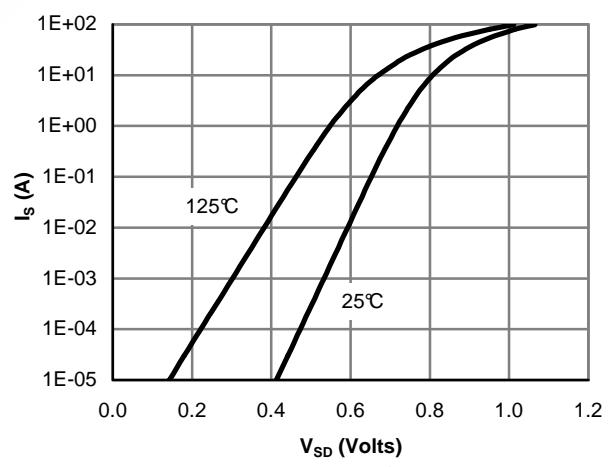
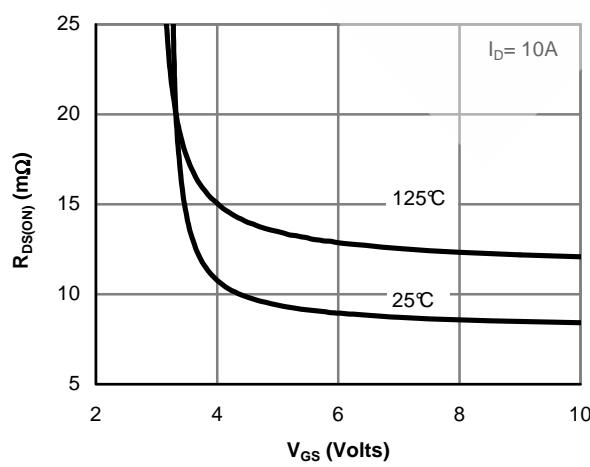
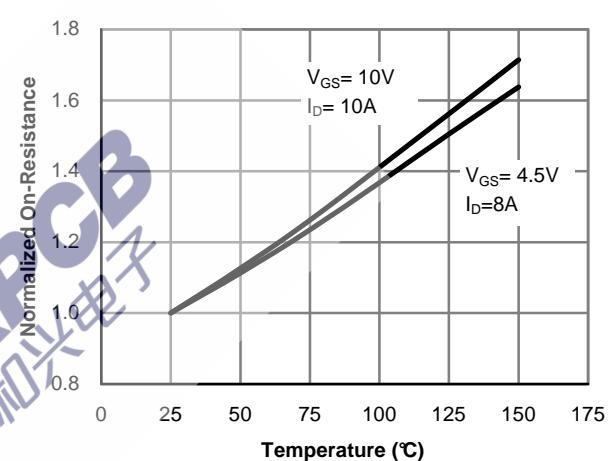
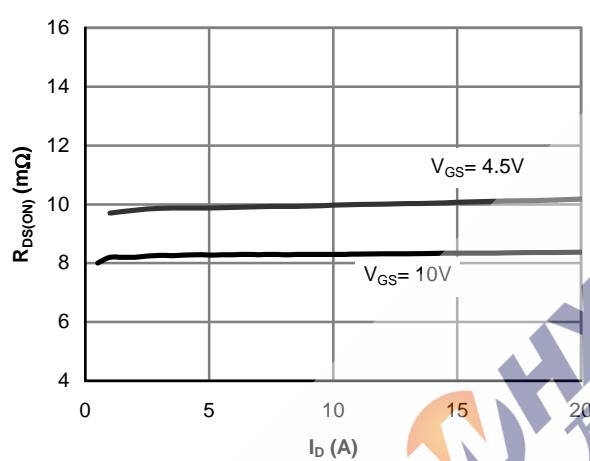
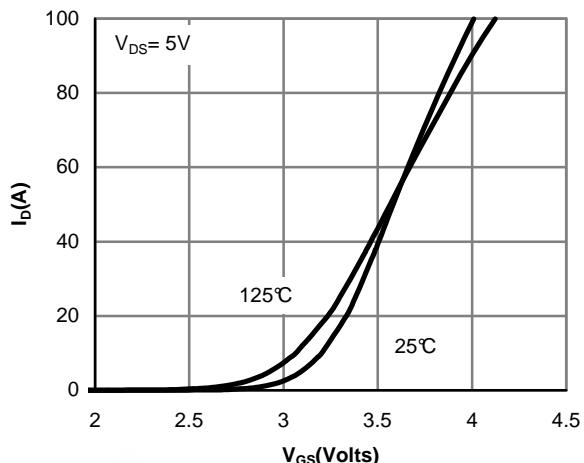
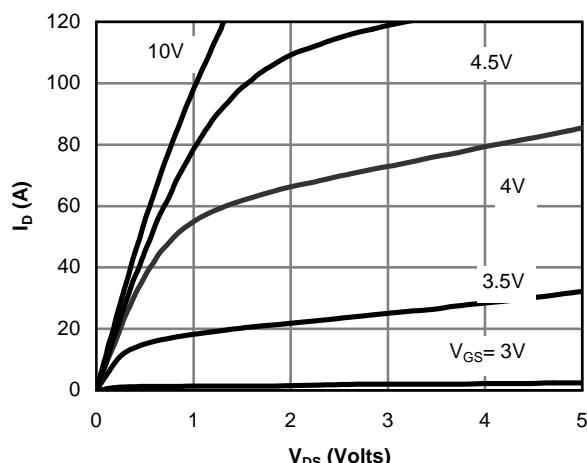
F. The current rating is based on the  $t \leq 10\text{s}$  thermal resistance rating.

G.  $E_{\text{AR}}$  and  $I_{\text{AR}}$  ratings are based on low frequency and duty cycles to keep  $T_J=25^\circ\text{C}$ .

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## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



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